

**PRODUCT / PROCESS CHANGE NOTIFICATION**

**1. PCN basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCN No.</b>	ADG/18/10897	
<b>1.3 Title of PCN</b>	Protection devices housed in SOT666 and SOT665 packages assembly transfer from current subco in China to another subco in China	
<b>1.4 Product Category</b>	Protection devices housed in SOT66x packages	
<b>1.5 Issue date</b>	2018-06-14	

**2. PCN Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	ROBERTSON HEATHER
<b>2.1.2 Phone</b>	+1 8475853058
<b>2.1.3 Email</b>	heather.robertson@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Richard RENARD
<b>2.1.2 Marketing Manager</b>	Eric PARIS
<b>2.1.3 Quality Manager</b>	Jean-Paul REBRASSE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	subco in China

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	subco 1 in China	subco 2 in China
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	no	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	The current assembly line will be terminated in December 2018.
<b>5.2 Customer Benefit</b>	MANUFACTURING FLEXIBILITY

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	marking, internal codification, QA number
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2018-05-15
<b>7.2 Intended start of delivery</b>	2018-08-27
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

10897 Public product.pdf  
10897 PCN-SOT66x.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
ESDA14V2BP6	ESDA14V2BP6	
	ESDA25-4BP6	
ESDA6V1-5P6	ESDA6V1-5P6	
	ESDA6V1P6	
497-3785-2-ND	ESDALC6V1P5	
ESDALC6V1P5	ESDALC6V1P5	
ESDALC6V1P6	ESDALC6V1P6	
	USBLC6-2P6	



## Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

**PCN Title :** Protection devices housed in SOT666 and SOT665 packages assembly transfer from current subco in China to another subco in China

**PCN Reference :** ADG/18/10897

**Subject :** Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

ESDA6V1-5P6	USBLC6-2P6	ESDA6V1P6
ESDALC6V1P5	ESDALC6V1P6	ESDA14V2BP6
ESDA25-4BP6	ESDALC6V1-5P6	



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